

DOCKET NO: 240708US



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
KENICHI HAYASHI, ET AL. : EXAMINER: WILLIAMS, A.O.
SERIAL NO: 10/625,583 :
FILED: JULY 24, 2003 : GROUP ART UNIT: 2826
FOR: SEMICONDUCTOR DEVICE AND :
SEMICONDUCTOR ASSEMBLY
MODULE WITH A GAP-CONTROLLING
LEAD STRUCTURE

AMENDMENT FILED CONCURRENTLY WITH REQUEST FOR CONTINUED
EXAMINATION UNDER 37 C.F.R. § 1.114

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Notice of Allowance dated October 3, 2005, please amend the
above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.